Specification of Thermoelectric Module TES1-24136

Descriptio

The 241 couples, 40mm x 40mm size module is a single stage module which is made of our high performance ingot to achieve superior cooling performance and 70°C or larger delta Tmax, is designed for superior cooling and heating applications. Beyond the standard below, we can design and manufacture the custom made module according to your special requirements.

Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

Application

- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

Performance Specification Sheet

| Th (°C) | 27 | 50 | Hot side temperature at environment: dry air, N ₂ |
|----------------------------|------|------|--|
| DT _{max} (°C) | 70 | 79 | Temperature Difference between cold and hot side of the |
| BT max (C) | | | module when cooling capacity is zero at cold side |
| U _{max} (Voltage) | 29.9 | 32.3 | Voltage applied to the module at DT _{max} |
| I _{max} (Amps) | 3.5 | 3.5 | DC current through the modules at DT _{max} |
| Q _{Cmax} (Watts) | 67.5 | 72.6 | Cooling capacity at cold side of the module under DT=0 °C |
| AC resistance (Ohms) | 6.5 | 7.0 | The module resistance is tested under AC |
| Tolerance (%) | ± 10 | | For thermal and electricity parameters |

Geometric Characteristics Dimensions in millimeters

COLD SIDE 70.02 HOT SIDE A 70.02 HB-0.35 4 600 (-) POSITIVE

Manufacturing Options

| A. Solder: | B. Sealant: |
|------------|-------------|

1. T100: BiSn (Tmelt=138°C) 1. NS: No sealing (Standard)

2. T200: CuAgSn (Tmelt = 217°C) 2. SS: Silicone sealant

3. T240: SbSn (Tmelt = 240° C) 3. EPS: Epoxy sealant

C. Ceramics: D. Ceramics Surface Options:

1. Alumina (Al₂O₃, white 96%)

1. Blank ceramics (not metalized)

2. Aluminum Nitride (AlN) 2. Metalized

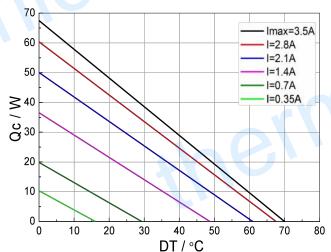
Ordering Option

| or worms of worm | | | | | | | |
|------------------|--|-------------|---|--|--|--|--|
| Suffix | Thickness H (mm) Flatness/ Parallelism (mm) | | Lead wire length(mm) Standard/Optional length | | | | |
| TF | 0:3.6± 0.10 | 0:0.05/0.05 | 400±3/Specify | | | | |
| TF | 1:3.6± 0.05 | 1:0.02/0.03 | 400±3/Specify | | | | |

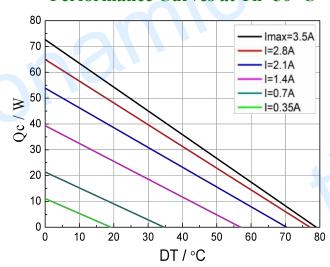
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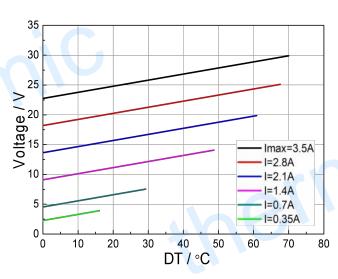


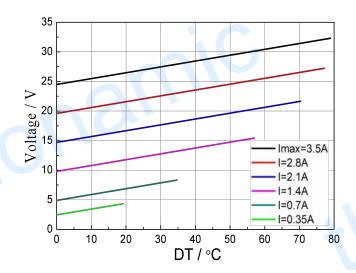


Performance Curves at Th=50 °C

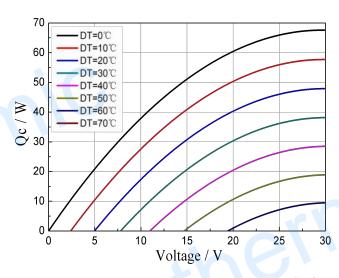


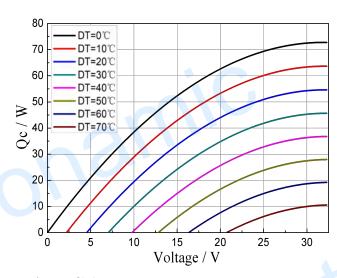
Standard Performance Graph Qc= f(DT)





Standard Performance Graph V = f(DT)





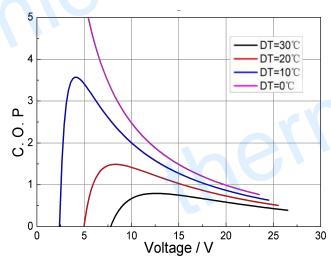
Standard Performance Graph Qc = f(V)

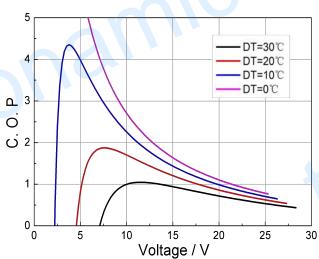
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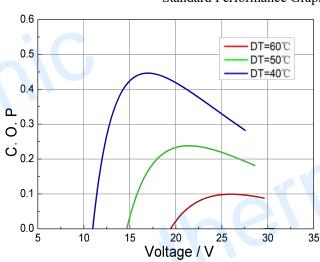


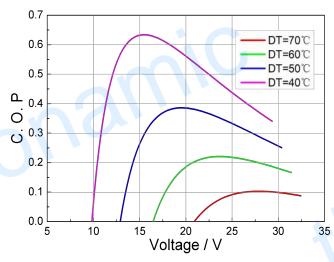
Performance Curves at Th=50 °C





Standard Performance Graph COP = f(V) of DT ranged from 0 to 30 °C





Standard Performance Graph COP = f(V) of DT ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power ($V \times I$).

Operation Caution

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating.
- Operation below I_{max} or V_{max}
- Work under DC

Note: All specifications subject to change without notice.